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\$8.95



Cooler Master MasterGel Pro V2 High Thermal Conductivity Compound

MGYZOSGN15MR3

Product Images





Short Description

High Quality That Runs Your Computer Smoothly MasterGel Pro V2, an upgraded compound of its old version with high CPU/GPU conductivity, providing better heat dissipation as well as improving heat transfer form chipset to cooler base. Apart from aesthetic design the thermal grease has been adjusted to match your performance needs.

Description

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HIGH QUALITY THAT RUNS YOUR COMPUTER SMOOTHLY

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W/M.K = 9





Features

- High Performance: Upgraded compound improves heat transfer from chipset cooler base or heat pipes
- Easy to Spread: Easy to spread and remove without damaging the surface
- Thermal Conductivity: High CPU/GPU conductivity W/m.k=9
- Volume (mL): 1.5

Specifications

Specifications:

Model

Brand COOLER MASTER

Series MasterGel Pro V2

Model MGY-ZOSG-N15M-R3

Details

Volume / Net Weight 1.5 ml

Thermal Conductivity 9.0 W/mK

Specific Gravity: 2.6 (g/cm3) (25°C)

Color: Gray

Specifications Improves heat transfer from chipset to cooler base or heatpipes

Precise and Even

Easy to spread and remove without surface damage

Features

Upgraded compound for better heat dissipation

High CPU/GPU conductivity (9 W/m.k)

Features

Improves heat transfer from chipset to cooler base or heat pipes

Easy to spread and remove without damaging the surface

Additional Information

Brand	Cooler Master
SKU	MGY-ZOSG-N15M-R3
Weight	0.2000
TIM Type	Paste



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